Product data sheet

1. General description

AC Thyristor power switch in a TO92 plastic package with self-protective capabilities against low and high energy transients

2. Features and benefits

- · Exclusive negative gate triggering
- Full cycle AC conduction
- · Remote gate separates the gate driver from the effects of the load current
- Very high noise immunity
- Safe clamping of low energy over-voltage transients
- Self-protective turn-on during high energy voltage transients

3. Applications

- Fan motor circuits
- Pump motor circuits
- · Lower-power highly inductive, resistive and safety loads

4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Absolute	maximum rating					
V_{DRM}	repetitive peak off-state voltage		-	-	600	V
I _{T(RMS)}	RMS on-state current	full sine wave; T _{lead} ≤ 71 °C; <u>Fig. 1</u>	-	-	0.8	Α
Static ch	aracteristics					
I _{GT}	gate trigger current	$V_D = 12 \text{ V; } I_T = 0.1 \text{ A; LD+ G-;}$ $T_j = 25 \text{ °C; } Fig. 6$	1	-	10	mA
		$V_D = 12 \text{ V; } I_T = 0.1 \text{ A; LD- G-;}$ $T_j = 25 \text{ °C; } Fig. 6$	1	-	10	mA

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	CM	common		LD
2	G	gate	3 2 1 TO-92 (SOT54)	G— Q
3	LD	load		CM 001aaj924

6. Ordering information

Table 3. Ordering information

Type number	Package Name	Orderable part number	Packing method	Small packing quantity	Package version	Package issue date
ACT108-600E	TO92	ACT108-600E,412	Bulk	1000	SOT54	14-Nov-2013
ACT108-600E	TO92	ACT108-600E,126	Ammo	2000	SOT54 wide pitch	14-Nov-2013
ACT108-600E	TO92	ACT108-600EQP	Reel	2000	SOT54 wide pitch	14-Nov-2013

7. Marking

Table 4. Marking codes

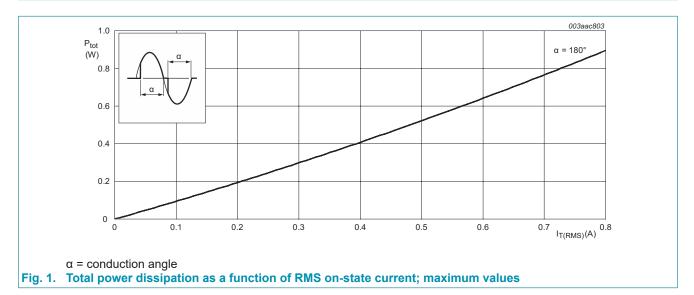
Type number	Marking codes
ACT108-600E	108-6E

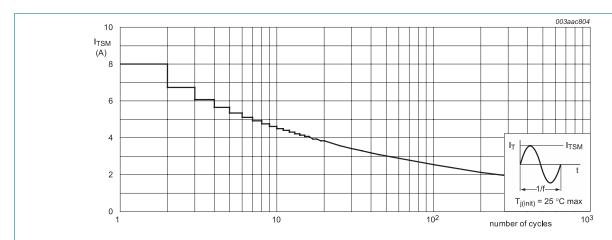
8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

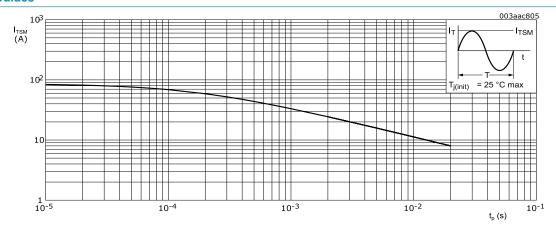
Symbol	Parameter	Conditions	Mi	n Max	Unit
V_{DRM}	repetitive peak off-state voltage		-	600	V
I _{T(RMS)}	RMS on-state current	full sine wave; T _{lead} ≤ 71 °C; <u>Fig. 1</u>	-	0.8	Α
I _{TSM}	non-repetitive peak on- state current	full sine wave; $T_{j(init)}$ = 25 °C; t_p = 20 ms; Fig. 2; Fig. 3	-	13	А
		full sine wave; $T_{j(init)} = 25 \text{ °C}$; $t_p = 16.7 \text{ ms}$	-	14.3	Α
l ² t	I ² t for fusing	t _P = 10 ms; sine-wave pulse	-	0.32	A ² s
dl _⊤ /dt	rate of rise of on-state current	I _G = 20 mA	-	100	A/µs
I _{GM}	peak gate current	$t_p = 20 \text{ us}$	-	1	Α
V_{GM}	peak gate voltage	positive applied gate voltage	-	15	V
$P_{G(AV)}$	average gate power	over any 20ms period	-	0.1	W
T _{stg}	storage temperature		-40	150	°C
T _j	junction temperature		-	125	°C
V_{PP}	peak pulse voltage	T _j = 25°C; non-repetitive, off-state; ten pulses on each voltage polarity; 20s or more between successive pulses; Fig. 4	-	2.5	kV





f = 50Hz

Fig. 2. Non-repetitive peak on-state current as a function of the number of sinusoidal current cycles; maximum values



t_p ≤ 20ms

Fig. 3. Non-repetitive peak on-state current as a function of pulse width; maximum values

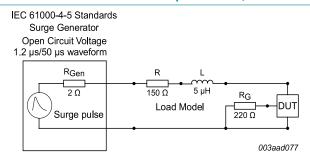


Fig. 4. Test circuit for inductive and resistive loads with conditions equivalent to IEC 61000-4-5

9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{\text{th(j-lead)}}$	thermal resistance from junction to lead	full cycle with heatsink compound; Fig. 5	-	-	60	K/W
$R_{\text{th(j-a)}}$	thermal resistance from junction to ambient free air	full cycle; printed-circuit board mounted; lead length 4mm	-	150	-	K/W

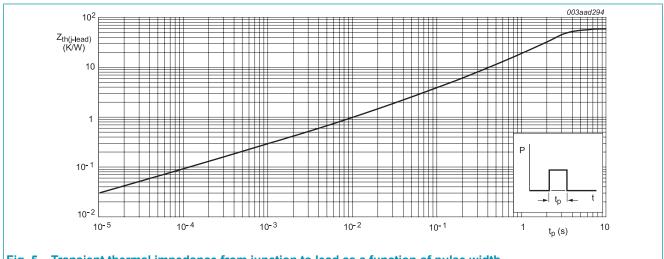
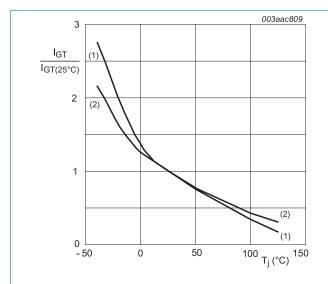


Fig. 5. Transient thermal impedance from junction to lead as a function of pulse width

10. Characteristics

Table 7. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static ch	aracteristics					
I _{GT}	gate trigger current	$V_D = 12 \text{ V}; I_T = 0.1 \text{ A}; LD+ G-;$ $T_j = 25 \text{ °C}; Fig. 6$	1	-	10	mA
		$V_D = 12 \text{ V; } I_T = 0.1 \text{ A; LD- G-;}$ $T_j = 25 \text{ °C; } Fig. 6$	1	-	10	mA
I _L	latching current	$V_D = 12 \text{ V}; I_G = 0.1 \text{ A}; LD+ G-;$ $T_j = 25 \text{ °C}; Fig. 7$	-	-	25	mA
		$V_D = 12 \text{ V}; I_G = 0.1 \text{ A}; LD- G-;$ $T_j = 25 \text{ °C}; Fig. 7$	-	-	20	mA
I _H	holding current	V _D = 12 V; T _j = 25 °C; <u>Fig. 7</u>	-	-	20	mA
V _T	on-state voltage	I _T = 1.1 A; T _j = 25 °C; <u>Fig. 8</u>	-	-	1.3	V
V_{GT}	gate trigger voltage	$V_D = 400 \text{ V}; I_T = 0.1 \text{ A}; T_j = 125 ^{\circ}\text{C};$	0.15	-	-	V
		$V_D = 12 \text{ V}; I_T = 0.1 \text{ A}; T_j = 25 \text{ °C};$	-	-	1	V
I _D	off-state current	V _D = 600 V; T _j = 25 °C	-	-	2	uA
		V _D = 600 V; T _j = 125 °C	-	-	0.2	mA
V _{CL}	clamping voltage	I_{CL} = 0.1 mA; t_p = 1 ms; T_j = 25 °C; Fig. 9	650	-	-	V
Dynamic	characteristics		·			
dV _D /dt	rate of rise of off-state voltage	V_{DM} = 402 V; T_j = 125 °C; $(V_{DM}$ = 67% of V_{DRM}); exponential waveform; gate open circuit; Fig. 10	2000	-	-	V/µs
dl _{com} /dt	rate of change of commutating current	$\begin{split} V_D &= 400 \text{ V; T}_j = 125 \text{ °C; } I_{T(RMS)} = 0.8 \text{ A;} \\ dV_{com}/dt &= 20 \text{ V/}\mu\text{s; (snubberless condition); gate open circuit; } \underbrace{\text{Fig. 11}}_{;}; \\ \underline{\text{Fig. 12}} \end{split}$	0.5	-	-	A/ms



(1) LD+ G-(2) LD- G-

Fig. 6. Normalized gate trigger current as a function of junction temperature

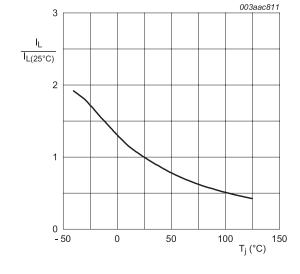
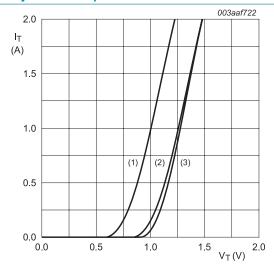


Fig. 7. Normalized latching current as a function of junction temperature



 V_o = 0.758 V; R_s = 0.263 Ω (1) T_j = 125 °C; typical values (2) T_j = 125 °C; maximum values (3) T_i = 25 °C; maximum values

Fig. 8. On-state current as a function of on-state voltage

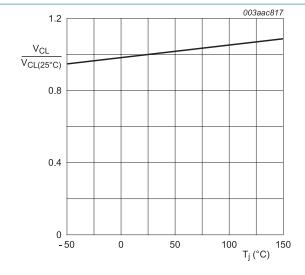
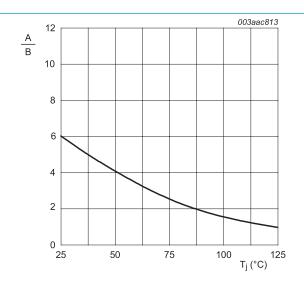


Fig. 9. Normalized clamping voltage (upper limit) as a function of junction temperature; minimum values

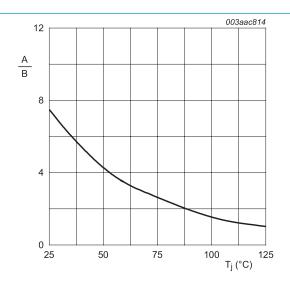
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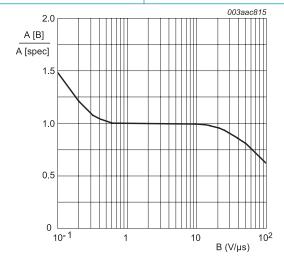
A = dV_D/dt at condition T_j °C B = dV_D/dt at condition T_j [125] °C

Fig. 10. Normalized rate of rise of off-state voltage as a function of junction temperature



A = dI_{com}/dt at condition T_j °C B = dI_{com}/dt at condition T_j [125] °C V_D = 400 V

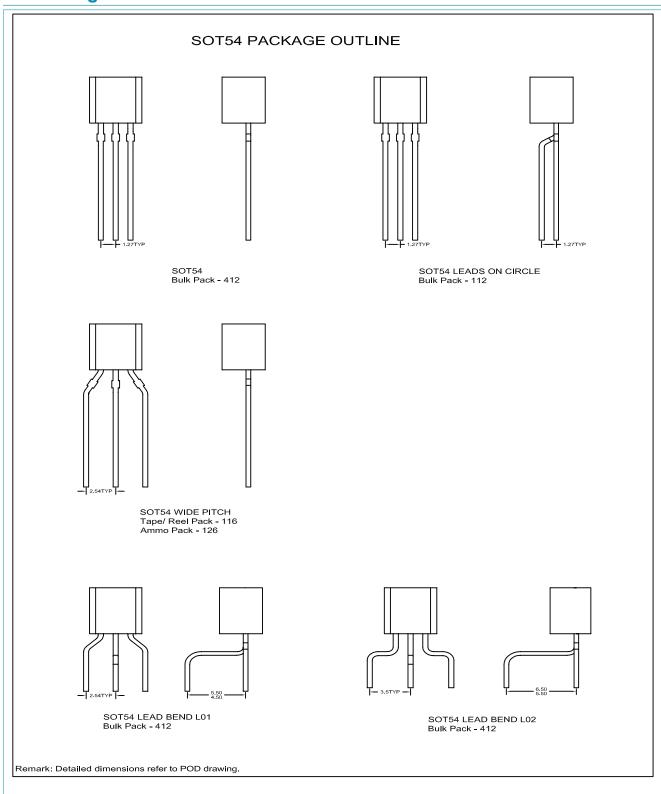
Fig. 11. Normalized critical rate of rise of commutating current as a function of junction temperature

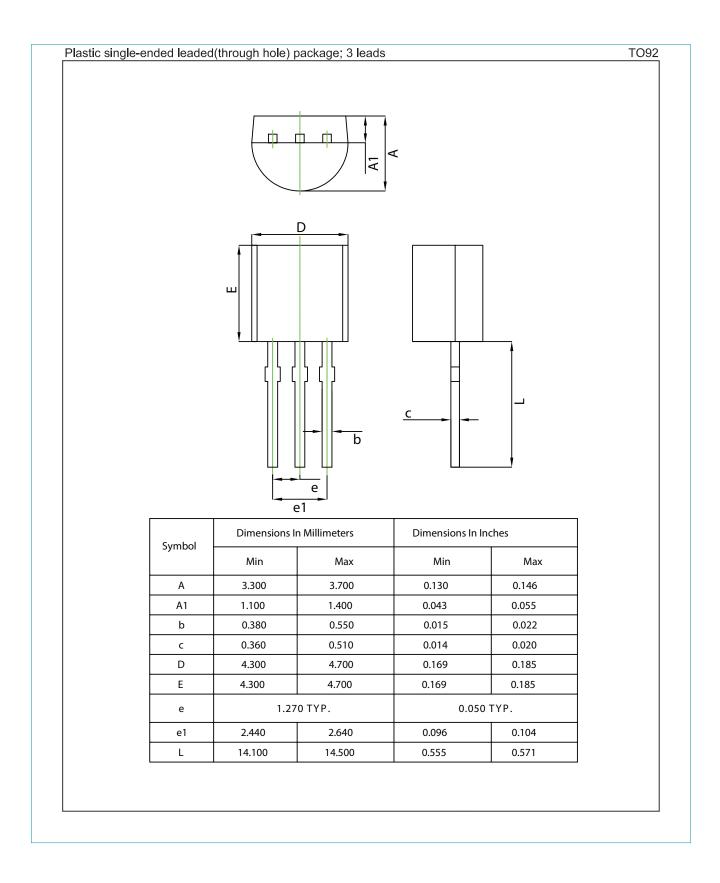


A [B] = dI_{com}/dt at condition B, dV_{com}/dt A [spec] is the data sheet value for dI_{com}/dt turn-off time is less than 20ms

Fig. 12. Normalized critical rate of change of commutating current as a function of critical rate of change of commutating voltage; minimum values

11. Package outline





12. Legal information

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Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
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